

Intelligent Power Module (IPM) 650 V, 50 A

NFAM5065L4BBA

General Description

The NFAM5065L4BBA is a fully-integrated inverter power module consisting of an independent High side gate driver, LVIC, six IGBT's and a temperature sensor (VTS), suitable for driving permanent magnet synchronous (PMSM) motors, brushless DC (BLDC) motors and AC asynchronous motors. The IGBT's are configured in a three-phase bridge with separate emitter connections for the lower legs for maximum flexibility in the choice of control algorithm.

The power stage has under voltage lockout protection (UVP). Internal boost diodes are provided for high side gate boost drive.

Features

- Three-phase 650 V, 50 A IGBT Module with Independent Drivers
- Active Logic Interface
- Built-in Under -Voltage Protection (UVP)
- Integrated Bootstrap Diodes and Resistors
- Separate Low-side IGBT Emitter Connections for Individual Current Sensing of Each Phase
- Temperature Sensor (VTS)
- UL1557 Certified (File No.339285)
- This Device is Pb -Free and RoHS Compliant

Applications

- Industrial Drives
- Industrial Pumps
- · Industrial Fans
- Industrial Automation

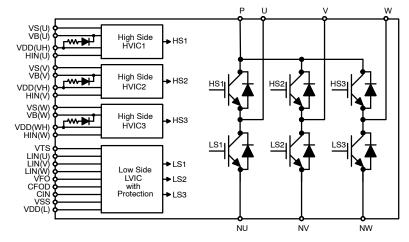
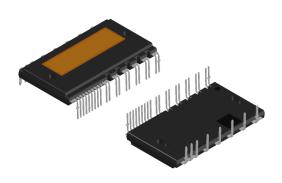


Figure 1. Application Schematic



DIP39, 54.5x31.0 EP -2 CASE MODGX

MARKING DIAGRAM



Device marking is on package top side

NFAM5065L4BBA = Specific Device Code
ZZZ = Assembly Lot Code
A = Assembly Location
T = Test Location
Y = Year
WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
NFAM5065L4BBA	DIP39 54.5 x 31.0 (Pb-Free)	90 Units / Box

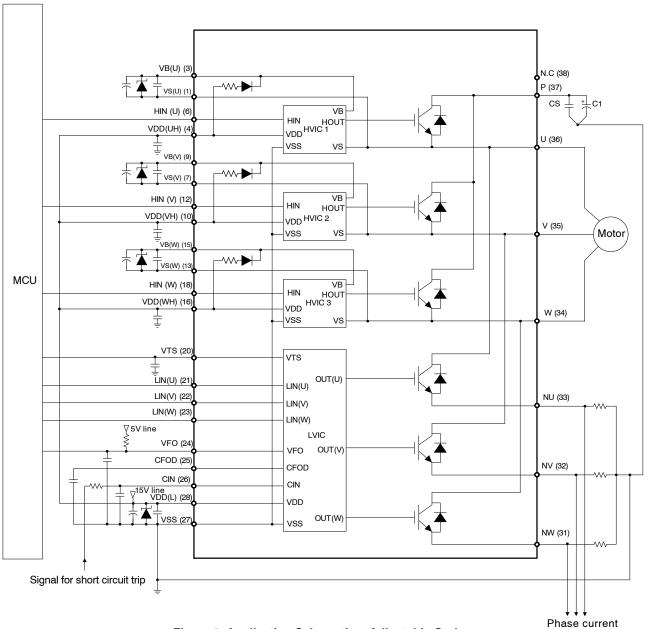


Figure 2. Application Schematic - Adjustable Option

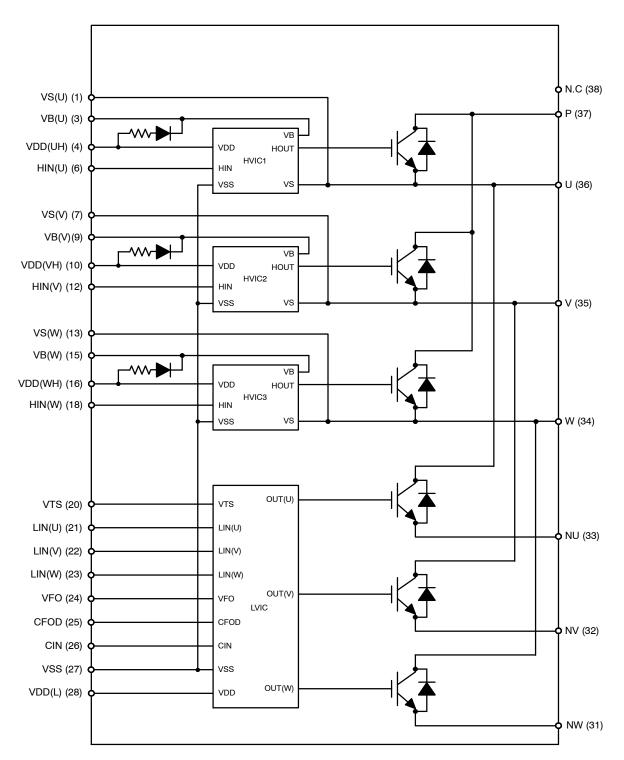


Figure 3. Equivalent Block Diagram

PIN FUNCTION DESCRIPTION

Pin	Name	Description
1	VS(U)	High -Side Bias Voltage GND for U phase IGBT Driving
(2)	-	Dummy
3	VB(U)	High -Side Bias Voltage for U phase IGBT Driving
4	VDD(UH)	High -Side Bias Voltage for U phase IC
(5)	-	Dummy
6	HIN(U)	Signal Input for High -Side U Phase
7	VS(V)	High -Side Bias Voltage GND for V phase IGBT Driving
(8)	-	Dummy
9	VB(V)	High -Side Bias Voltage for V phase IGBT Driving
10	VDD(VH)	High -Side Bias Voltage for V phase IC
(11)	-	Dummy
12	HIN(V)	Signal Input for High -Side V Phase
13	VS(W)	High -Side Bias Voltage GND for W phase IGBT Driving
(14)	-	Dummy
15	VB(W)	High -Side Bias Voltage for W phase IGBT Driving
16	VDD(WH)	High -Side Bias Voltage for W phase IC
(17)	-	Dummy
18	HIN(W)	Signal Input for High -Side W Phase
(19)	-	Dummy
20	VTS	Voltage Output for LVIC Temperature Sensing Unit
21	LIN(U)	Signal Input for Low -Side U Phase
22	LIN(V)	Signal Input for Low -Side V Phase
23	LIN(W)	Signal Input for Low -Side W Phase
24	VFO	Fault Output
25	CFOD	Capacitor for Fault Output Duration Selection
26	CIN	Input for Current Protection
27	VSS	Low -Side Common Supply Ground
28	VDD(L)	Low -Side Bias Voltage for IC and IGBTs Driving
(29)	-	Dummy
(30)	-	Dummy
31	NW	Negative DC -Link Input for U Phase
32	NV	Negative DC -Link Input for V Phase
33	NU	Negative DC -Link Input for W Phase
34	W	Output for U Phase
35	V	Output for V Phase
36	U	Output for W Phase
37	Р	Positive DC -Link Input
38	N.C	No Connection
(39)	-	Dummy

Pins of () are the dummy for internal connection. These pins should be no connection.

ABSOLUTE MAXIMUM RATINGS (Tc = 25 °C) (Note 2)

Symbol	Rating	Conditions	Value	Unit
VPN	Supply Voltage	P –NU, NV, NW	450	V
VPN(surge)	Supply Voltage (Surge)	P -NU, NV, NW (Note 3)	550	V
VPN(PROT)	$ \begin{array}{lll} \text{VPN(PROT)} & \text{Self Protection Supply Voltage Limit} \\ & \text{(Short -Circuit Protection Capability)} & \text{VDD} = \text{VBS} = 13.5 \text{ V} \sim 16.5 \text{ V}, \text{Tj} = 150 \text{ °C}, \\ & \text{Vces} < 650 \text{ V}, \text{Non -repetitive}, < 2 \mu\text{S} \\ \end{array} $		400	V
Vces	Collector -emitter voltage		650	V
VRRM	Maximum Repetitive Reverse Voltage		650	V
±lc	Each IGBT Collector Current		±50	Α
±lcp	Each IGBT Collector Current (Peak)	Under 1 ms Pulse Width	±100	Α
VDD	Control Supply Voltage	VDD(UH,VH,WH), VDD(L)-VSS	-0.3 to 20	V
VBS High -Side VB(U)-VS(U VB(W)-VS(V VB(W)-VS(V)-VS(V VB(W)-VS(V VB(W)-VS(V VB(W)-VS(V VB(W)-VS(V VB(W)-VS(V VB(W)-VS(V VB(W)-VS(V VB(W)-VS(V)-VS(V VB(W)-VS(V)-VS(V)-VS(V VB(W)		VB(U)-VS(U), VB(V)-VS(V), VB(W)-VS(W)	-0.3 to 20	٧
VIN	Input Signal Voltage	HIN(U), HIN(V), HIN(W), LIN(U), LIN(V), LIN(W)–VSS	-0.3 to VDD	V
VFO	Fault Output Supply Voltage	VFO-VSS	-0.3 to VDD	V
IFO	Fault Output Current	Sink Current at VFO pin	2	mA
VCIN	Current Sensing Input Voltage	CIN-VSS	-0.3 to VDD	٧
Pc	Corrector Dissipation	Per One Chip	125	W
Tj	Operating Junction Temperature		-40 to +150	°C
Tstg	Storage temperature		-40 to +125	°C
Tc	Module Case Operation Temperature		-40 to +125	°C
Viso	Isolation voltage	60 Hz, Sinusoidal, AC 1 minute, Connection Pins to Heat Sink Plate	2500	Vrms

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

2. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe

THERMAL CHARACTERISTICS

Symbol	Rating	Conditions	Min	Тур	Max	Unit
Rth(j-c)Q		Inverter IGBT Part (per 1/6 module)	-	-	1.0	°C/W
Rth(j-c)F	Resistance	Inverter FWD Part (per 1/6 module)	-	_	1.7	°C/W

^{4.} Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe Operating parameters.

Operating parameters.

^{3.} This surge voltage developed by the switching operation due to the wiring inductance between P and NU, NV, NW terminal.

RECOMMENDED OPERATING CONDITIONS

Symbol	Rating	Cond	itions	Min	Тур	Max	Unit
VPN	Supply Voltage	P-NU, NV, NW		_	300	400	V
VDD	Gate Driver Supply	VDD(UH,VH,WH),	VDD(L)-VSS	13.5	15	16.5	V
VBS	- Voltages	VB(U)-VS(U), VB(VB(W)-VS(W)	(V)-VS(V),	13.0	15	18.5	V
dVDD / dt, dVBS / dt	Supply Voltage Variation			-1	-	1	V/μs
fPWM	PWM Frequency			1	-	20	kHz
DT	Dead Time	Turn-off to Turn-on (external)		1.5	-	-	μs
lo	Allowable r.m.s. Current	VPN = 300 V, VDD = 15 V, P.F. = 0.8	fPWM = 5 kHz	_	-	30.0	Arms
		Tc ≤ 125 °C, Tj ≤ 150 °C (Note 5)	fPWM = 15 kHz	_	-	21.2	
PWIN (on)	Allowable Input Pulse Width	200 V ≤ VPN ≤ 400 V 13.5 V ≤ VDD ≤ 16.5 V 13.0 V ≤ VBS ≤ 18.5 V -20 °C ≤ Tc ≤ 100 °C		1.0	_	_	μs
PWIN (off)				1.5	_	_	
	Package Mounting Torque	M3 type screw		0.6	0.7	0.9	Nm

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

5. Allowable r.m.s current depends on the actual conditions.

ELECTRICAL CHARACTERISTICS (Tc = 25 °C, VDD = 15 V, VBS = 15 V, unless otherwise noted) (Note 7)

Symbol	Paramet	er	Test Conditions	Min	Тур	Max	Unit
INVERTER SE	CTION						
Ices	Collector-Emitter L	eakage	Vce = Vces, Tj = 25 °C	-	-	1	mA
	Current		Vce = Vces, Tj = 150 °C	-	-	10	mA
VCE(sat)	Collector-Emitter S Voltage	aturation	VDD = VBS = 15 V, IN = 5 V Ic = 50 A, Tj = 25 °C	-	1.65	2.30	V
			VDD = VBS = 15 V, IN = 5 V Ic = 50 A, Tj = 150 °C	-	1.85	-	V
VF	VF FWDi Forward Voltage	age	IN = 0 V, Ic = 50 A, Tj = 25 °C	-	2.00	2.40	V
			IN = 0 V, Ic = 50 A, Tj = 150 °C	-	2.00	-	V
ton	Switching Times	ching Times High Side	VPN = 300 V, VDD(H) = VDD(L) = 15 V Ic = 50 A, Tj = 25 °C, IN = 0 \Leftrightarrow 5 V Inductive Load	0.90	1.50	2.10	μs
tc(on)				-	0.40	0.70	μs
toff				-	1.80	2.40	μs
tc(off)				-	0.25	0.75	μs
trr				-	0.25	-	μs
ton		Low Side	VPN = 300 V, VDD(H) = VDD(L) = 15 V	0.90	1.50	2.10	μs
tc(on)		Ic = 50 A, Tj = 25 °C, IN = 0 ↔ 5 V Inductive Load	-	0.30	0.60	μs	
toff			-	1.70	2.30	μs	
tc(off)	7			-	0.25	0.75	μs
trr				-	0.25		μs

^{6.} Flatness tolerance of the heatsink should be within –50 μ m to +100 μ m.

ELECTRICAL CHARACTERISTICS (Tc = 25 °C, VDD = 15 V, VBS = 15 V, unless otherwise noted) (Note 7) (continued)

Symbol	Parameter	Test Conditi	Test Conditions		Тур	Max	Unit
RIVER SECT	TION	<u>'</u>					
IQDDH	Quiescent VDD Supply Current	VDD(UH,VH,WH) = 15 V, HIN(U,V,W) = 0 V	VDD(UH)-VSS VDD(VH)-VSS VDD(WH)-VSS	_	-	0.30	mA
IQDDL		VDD(L) = 15 V, LIN(U,V,W) = 0 V	VDD(L)-VSS	-	-	3.50	mA
IPDDH	Operating VDD Supply Current	VDD(UH,VH,WH) = 15 V, fPWM = 20 kHz, Duty = 50%, Applied to one PWM Signal Input for High-Side	VDD(UH)-VSS VDD(VH)-VSS VDD(WH)-VSS	-	-	0.40	mA
IPDDL		VDD(L) = 15 V, fPWM = 20 kHz, Duty = 50%, Applied to one PWM Signal Input for Low-Side	VDD(L)-VSS	-	-	6.00	mA
IQBS	Quiescent VBS Supply Current	VBS = 15 V, HIN(U,V,W) = 0 V	VB(U)-VS(U) VB(V)-VS(V) VB(W)-VS(W)	-	-	0.30	mA
IPBS	Operating VBS Supply Current	VDD = VBS = 15 V, fPWM = 20 kHz, Duty = 50%, Applied to one PWM Signal Input for High-Side	VB(U)-VS(U) VB(V)-VS(V) VB(W)-VS(W)	-	-	5.00	mA
VIN(ON)	ON Threshold Voltage	HIN(U,V,W)-VSS, LIN(U,V,W)-VSS		-	_	2.6	V
VIN(OFF)	OFF Threshold Voltage				-	-	V
VCIN(ref)	Short Circuit Trip Level	VDD = 15 V, CIN-VSS		0.46	0.48	0.50	V
UVDDD	Supply Circuit	Detection Level		10.3	-	12.5	V
UVDDR	Under-Voltage Protection	Reset Level		10.8	-	13.0	V
UVBSD	1	Detection Level		10.0	-	12.0	V
UVBSR		Reset Level		10.5	-	12.5	V
VTS	Voltage Output for LVIC Temperature Sensing Unit	VTS-VSS = 10 nF, Temp. = 2	25 °C (Note 10)	1.145	1.250	1.380	V
VFOH	Fault Output Voltage	VDD = 0 V, CIN = 0 V, VFO Circuit: 10 k Ω to 5 V Pu	VDD = 0 V, CIN = 0 V, VFO Circuit: 10 kΩ to 5 V Pull-up		-	-	V
VFOL		VDD = 0 V, CIN = 1 V, VFO Circuit: 10 kΩ to 5 V Pull-up		-	-	0.95	V
tFOD	Fault-Output Pulse Width	CFOD = 22 nF		1.6	2.4	-	ms
OOTSTRAP	SECTION						
VF	Bootstrap Diode Forward Voltage	If = 0.1 A	If = 0.1 A		4.6	5.8	V
RBOOT	Built-in Limiting Resistance			30	38	46	Ω

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{7.} Performance guaranteed over the indicated operating temperature range by design and/or characterization tested at Tj = Ta = 25 °C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.

^{8.} The fault -out pulse width t_{FOD} depends on the capacitance value of CFÓD according to the following approximate equation: tFOD = 0.11 × 10⁶ × CFOD (s).

^{9.} Values based on design and/or characterization.

^{10.}VTS is only for sensing temperature of LVIC and can not shutdown IGBTs automatically. To get linear VTS output voltage at low temperature below room temperature, 5 k Ω pull down resistor should be inserted between VTS and VSS.

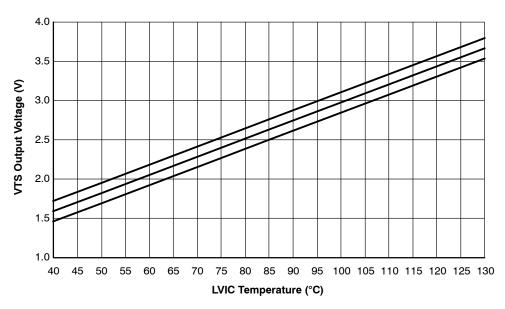


Figure 4. Temperature of LVIC versus VTS Characteristics

REVISION HISTORY

Revision	Description of Changes	Date
2	Updated MIN limit spec of VTS item in the Electrical Characteristics Table (DRIVER SECTION) on page 7.	7/1/2025

This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.







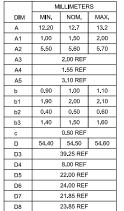
DIP39, 54.50x31.00x5.60, 1.78P EP-2 CASE MODGX **ISSUE B**

DATE 05 MAY 2025

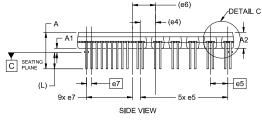
NOTES

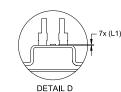
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009. CONTROLLING DIMENSION: MILLIMETERS
- DIMENSION b and c APPLY TO THE PLATED LEADS AND ARE MEASURED BETWEEN 1.00 AND 2.00 FROM THE LEAD TIP POSITION OF THE LEAD IS DETERMINED AT THE BASE OF THE 3.
- LEAD WHERE IT EXITS THE PACKAGE BODY
- AREA FOR 2D BAR CODE
- SHORTENED/CUT PINS ARE 2,5,8,11,14,17,19,29, 30 AND 39
- E SIDE FLASH

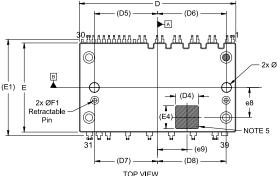
DIMENSIONS D AND	_ E L	וו וטאוטכ	NCLUDE	ILL
PROTRUSION WHICH	IS ~(0.12 FOR	EACH SI	DΕ

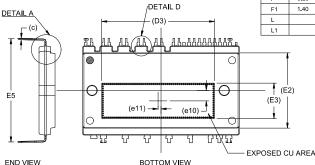


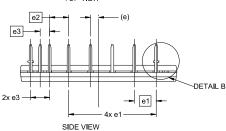
	MILLIMETERS				
DIM	MIN.	NOM.	MAX.		
E	30.90	31.00	31,10		
E1		33.50 REF			
E2		26.14 REF			
E3		12.35 REF			
E4		8.00 REF			
E5	35.40	35.90	36.40		
е		2.81 REF			
e1		7.62 BSC			
e2	6.60 BSC				
e3	3.30 BSC				
e4	5.35 REF				
e5	6.10 BSC				
e6		8.02 REF			
e7		1.78 BSC			
e8		10.35 REF			
e9		10.25 REF			
e10		3.60 REF			
e11		1.00 REF			
e12	0.89 BSC				
F	3.20 3.30 3.40				
F1	1.40	1.50	1.60		
L	5.60 REF				
L1		0.10 REF			

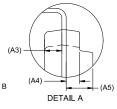


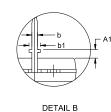


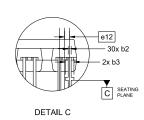




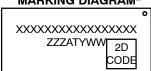








GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code

= Assembly Lot Code 777

ΑT = Assembly & Test Location

= Year WW = Work Week *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " • ", may or may not be present. Some products may not follow the Generic Marking.

Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DOCUMENT NUMBER:** 98AON05290H **DESCRIPTION:** DIP39, 54.50x31.00x5.60, 1.78P EP-2 PAGE 1 OF 1

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. **onsemi** makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI., and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems. or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales